



(11) **EP 2 034 469 B1**

(12) **EUROPEAN PATENT SPECIFICATION**

(45) Date of publication and mention
of the grant of the patent:
17.01.2018 Bulletin 2018/03

(51) Int Cl.:
H01L 27/32^(2006.01)

(21) Application number: **08170139.3**

(22) Date of filing: **13.09.2002**

(54) **Organic electroluminescent display device**
Organische elektrolumineszente Anzeige-Vorrichtung
Dispositif d'affichage électroluminescent organique

(84) Designated Contracting States:
DE FR GB

(30) Priority: **13.09.2001 JP 2001278628**

(43) Date of publication of application:
11.03.2009 Bulletin 2009/11

(60) Divisional application:
09168106.4 / 2 131 343

(62) Document number(s) of the earlier application(s) in
accordance with Art. 76 EPC:
02763028.4 / 1 426 914

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Description

TECHNICAL FIELD

[0001] The present invention relates to an electronic device and a method of manufacturing the same, and an electronic instrument.

BACKGROUND ART

[0002] A liquid crystal panel is an example of an electronic device having a pair of electrodes opposing to each other. In the liquid crystal panel, voltage is applied between a first electrode and a second electrode. External terminals are formed on a substrate on which the first electrode is formed. The second electrode is electrically connected with some of the external terminals formed on the substrate. In more detail, conductive sections protrude from the substrate, and wiring from the external terminals and the second electrode are electrically connected via the conductive sections. The conductive sections are locally disposed only at corner areas of the liquid crystal panel. Therefore, since the conductive sections are small, a problem of high conductive resistance occurs. However, in a conventional liquid crystal panel, larger conductive sections cannot be provided because of tight routing of wiring on the substrate.

DISCLOSURE OF THE INVENTION

[0003] JP 2001-101398 and JP 2000-357584 both disclose a circuit board for a display device with external terminals provided on one side of the circuit board. A wiring for connecting the external terminals and a common electrode for a plurality of pixels lies directly between the external terminals and the common electrode. The wiring is widened in the direction of the one side on which the external terminals are disposed.

DISCLOSURE OF THE INVENTION

[0004] The present invention is devised to solve the conventional problems and the objective of the present invention is to provide an electronic device in which electrical connection to an electrode can be achieved with reduced resistance.

[0005] In accordance with a first aspect of the invention, there is provided an organic electroluminescent device as set out in claim 1. Preferred features are set out in claims 2 to 4.

[0006] Accordingly, a large conductive section can be formed and the first wiring pattern can be electrically connected with the first electrode with reduced resistance by forming the first wiring pattern to surround the operating region with an opening

BRIEF DESCRIPTION OF THE DRAWINGS.

[0007]

FIG. 1 is a plan view of the electronic device according to one embodiment of the present invention.

FIG. 2 is a plan view of details of the electronic device according to the embodiment illustrated in Fig. 1.

FIG. 3 is a cross-sectional view taken along the line III-III of FIG. 2.

FIG. 4 is a circuitry diagram of an electronic device according to one embodiment of the present invention.

FIG. 5 is a schematic view showing an electronic instrument according to one embodiment of the present invention.

FIG. 6 is a schematic view showing another electronic instrument according to another embodiment of the present invention.

BEST MODE FOR CARRYING OUT THE INVENTION

[0008] Embodiments of the present invention are described below with reference to the drawings.

[0009] FIG. 1 is a view illustrating an electronic device according to one embodiment of the present invention. An electronic device 1 may be an electro-optical device such as a display (a display panel, for example) or a storage. The electronic device 1 shown in FIG. 1 is an organic EL (electroluminescent) panel. FIG. 2 is a view showing details of the electronic device 1. FIG. 3 is a cross-sectional view taken along the line III-III shown in FIG. 2. The electronic device 1 includes first and second wiring patterns 10 and 20. The first wiring pattern 10 is located outside the second wiring pattern 20 in the electronic device 1.

[0010] The second wiring pattern 20 is provided between an operating region 54 and the first wiring pattern 10. The second wiring pattern 20 consists of a plurality of (three or more, for example (first to third in the example shown in FIG. 2)) split wiring patterns 11 to 13. The first to third split wiring patterns 11 to 13 are separated from each other. The first split wiring pattern 11 is formed at a position apart from the split wiring patterns 12 and 13 (at the side of the operating region 54 opposite to the first split wiring pattern 11 in which a plurality of operating elements 50 are formed, for example). The split wiring patterns other than the first split wiring pattern 11 (second and third split wiring patterns 12 and 13) are disposed adjacent to each other. Part of at least one split wiring pattern (first split wiring pattern 11, for example) and part of other split wiring patterns (second and third split wiring patterns 12 and 13, for example) are disposed on the opposite sides of the operating region 54. At least two split wiring patterns (the second and third split wiring patterns 12 and 13, for example) may be partially adjacent to each other between the operating region 54 and an edge of the substrate 64, and at least the adjacent parts

have different widths. At least one of the split wiring patterns (the first split wiring pattern 11, for example) may have a first section which is adjacent to another one of the other split wiring patterns (second split wiring pattern 12, for example) between the operating region 54 and an edge of the substrate 64, and a second section which has the width larger than the first section.

[0011] The second wiring pattern 20 has a plurality of terminals 14. In this embodiment, the terminals 14 are ends of the split wiring patterns 11 to 13. Each of the split wiring patterns 11 to 13 is connected with at least one (two or more in FIG. 1) terminal 14. The terminals 14 are arranged in the widthwise direction. The terminals 14 are arranged so that the tips are uniformly positioned. The second wiring pattern 20 is pulled out to one side of the substrate 64.

[0012] The second wiring pattern 20 has a first section extending from the terminals 14, and a second section extending in a direction which intersects the direction in which the first section extends. For example, the first split wiring pattern 11 has a first section 30 extending from the terminals 14, and a second section 32 extending in a direction which intersects the direction in which the first section 30 extends (at right angles in FIG. 1). The first and second sections 30 and 32 form an L-shape. In more detail, the first section 30 extends in a direction perpendicular (or substantially perpendicular) to a line (an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. The second section 32 extends in a direction parallel (or substantially parallel) to that line (an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. A cut portion 34 is formed in the second section 32 so as to avoid at least one of the second and third split wiring patterns 12 and 13 (both in FIG. 1). The cut portion 34 is formed to reduce the width of the second section 32 (or a length in a direction perpendicular to the extending direction of the second section 32). The cut portion 34 shown in FIG. 1 is formed on the far side of the second section 32 from the first section 30 (or the outside of the L-shape formed of the first and second sections 30 and 32, for example). As a modification example, the cut portion 34 may be formed on the near side of the second section 32 from the first section 30 (or the inside of the L-shape formed of the first and second sections 30 and 32, for example).

[0013] The second split wiring pattern 12 has a first section 36 extending from the terminals 14, and a second section 38 extending in a direction intersecting the first section 36 (at right angles in FIG. 1). The first and second sections 36 and 38 form an L-shape. In more detail, the first section 36 extends in a direction perpendicular (or substantially perpendicular) to a line (or an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. The second section 38 extends in a direction parallel (or substantially parallel) to a line (or an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. A cut

portion 40 is formed in the second section 38 so as to avoid at least one of the first and third split wiring patterns 11 and 13 (the first split wiring pattern 11 in FIG. 1). The cut portion 40 is formed to reduce the width of the second section 38 (or a length in a direction perpendicular to the extending direction of the second section 38). The cut portion 40 shown in FIG. 1 is formed on the near side of the second section 38 from the first section 30 (or the inside of the L-shape formed of the first and second sections 36 and 38, for example). As a modification example, the cut portion 40 may be formed on the far side of the second section 38 from the first section 30 (or the inside of the L-shape formed of the first and second sections 36 and 38, for example).

[0014] The third split wiring pattern 13 has a first section 42 extending from the terminals 14, and a second section 44 extending in a direction intersecting the first section 42 extends (at right angles in FIG. 1). The first and second sections 42 and 44 form an L-shape. In more detail, the first section 42 extends in a direction perpendicular (or substantially perpendicular) to a line (or an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. The second section 44 extends in a direction parallel (or substantially parallel) to a line (or an edge line of the substrate 64, for example) along which tips of the terminals 14 are arranged. As a modification example, a cut portion may be formed in the second section 44 so as to avoid at least one of the first and third split wiring patterns 11 and 13. The details of the cut portion are the same as the above-described cut portions 34 and 40.

[0015] In this embodiment, the first section 30 of the first split wiring pattern 11 and the first sections 36 and 42 of the second and third split wiring patterns 12 and 13 are disposed on opposite sides of the operating region 54 in which the operating elements 50 are formed. The second section 32 of the first split wiring pattern 11 and the second sections 38 and 44 of the second and third split wiring patterns 12 and 13 extend in opposite directions respectively from the first section 30 and the first sections 36 and 42. The second section 32 of the first split wiring pattern 11 and the second sections 38 and 44 of the second and third split wiring patterns 12 and 13 are at least partially adjacent to each other. The second wiring pattern 20 forms a C-shape. In more detail, the first to third split wiring patterns 11 to 13 surround a region (the operating region 54, for example) from three directions. The first to third split wiring patterns 11 to 13 surround the region with at least one side of the region (or one side of the substrate 64, for example) remained not to be surrounded. For example, the first to third split wiring patterns 11 to 13 surround three sides of a quadrilateral region, but leave it open on one side.

[0016] The first split wiring pattern 11 is formed to be wider than the second and third split wiring patterns 12 and 13. The width used herein refers to the lengths of the first to third split wiring patterns 11 to 13 in a direction perpendicular to the extending direction of the first to third

split wiring patterns 11 to 13. The width of the first section 30 of the first split wiring pattern 11 is greater than the widths of the first sections 36 and 42 of the second and third split wiring patterns 12 and 13. The width of at least part of the second section 32 of the first split wiring pattern 11 is greater than the widths of the second sections 38 and 44 of the second and third split wiring patterns 12 and 13. In the example shown in FIG. 1, the width of the second section 32 of the first split wiring pattern 11 in the area in which the cut portion 34 is formed is smaller than the second section 38 of the second split wiring pattern 12 in the area in which the cut portion 40 is not formed.

[0017] The second wiring pattern 20 is electrically connected with second electrodes 52 (see FIG. 3). The second electrodes 52 consist of a plurality of electrodes. Each of the second electrodes 52 is provided corresponding to each of the operating elements 50. The second electrodes 52 supply electrical energy to each of the operating elements 50. At least a part (only a part in many cases) of the second electrode 52 is formed to overlap the operating elements 50. In this embodiment, the second electrodes 52 are formed by transparent electrodes made of ITO (indium tin oxide) so that the second electrodes 52 transmit light, for example. The second electrodes 52 may be formed in the shape of a matrix. The second electrodes 52 are formed in the region surrounded by the second wiring pattern 20. In the example shown in FIG. 2, the second electrodes 52 are disposed on one side (side opened by the second wiring pattern 20 (left side in FIG. 2)) of the second sections 32, 38, and 44 of the first to third split wiring patterns 11 to 13. Multilayer wiring patterns may be used to electrically connect the second sections 32, 38, and 44 of the first to third split wiring patterns 11 to 13 with the second electrodes 52.

[0018] The first wiring pattern 10 and the operating region 54 or the second electrodes 52 are disposed on the opposite sides of the second wiring pattern 20. The first wiring pattern 10 is formed to have a length larger than the width of the operating region 54. Therefore, since the first wiring pattern 10 is provided outside the operating region 54, a conductive section 70 can be made to have a sufficient length. In the case where the operating region 54 is rectangular (or square), the width of the operating region 54 may be the length of one side. In the case where the operating region 54 is polygonal, the width of the operating region 54 may be the length of the diagonal. In the case where the operating region 54 is circular, the width of the operating region 54 may be the diameter (major axis or minor axis if the operating region 54 is oval). The first wiring pattern 10 is provided outside the operating region 54 in the substrate 64. The first wiring pattern 10 is formed to have a length at least equal to the length of one side of the operating region 54. The first wiring pattern 10 forms a C-shape. In more detail, the first wiring pattern 10 surrounds a region (or the operating region 54, for example) from three directions. The first wiring pattern 10 surrounds the operating region 54 except part of the surrounding area in which a third wiring

pattern 60 is formed. The first wiring pattern 10 opens in at least one direction. For example, the first wiring pattern 10 surrounds three sides of a quadrilateral region, but leaves it open on one side. The first and second wiring patterns 10 and 20 open in the same direction. As shown in FIG. 3, the first wiring pattern 10 may be formed by a plurality of layers.

[0019] An optical device (electro-optical device) may be formed by providing an optical material (light-emitting material, liquid crystal, or the like) to the operating elements 50. Electro-optical elements may be formed by using an optical material. In this case, the operating region 54 may be a display region (display section). The shape of the operating region 54 is not limited to a rectangle (or square). The operating region 54 may be polygonal other than rectangular, circular, or oval. Each of the operating elements 50 has one of light-emitting materials which emit different colors of light. The split wiring patterns 11 to 13 are provided according to colors of light. In the electronic device 1 as an organic EL panel, light-emitting materials of red, green, and blue may be provided to the operating elements 50. A hole transport layer and an electron transport layer may be formed in the operating elements 50. As described above, since the first split wiring pattern 11 is wider than the second and third split wiring patterns 12 and 13, the first split wiring pattern 11 may be provided for a material exhibiting poor light-emitting efficiency (or a polymer material such as a blue light-emitting material). This enables a heavy current (or a stable current) to be supplied from the wide first split wiring pattern 11. In this case, the second and third split wiring patterns 12 and 13 are provided for low-molecular-weight materials (such as red and green light-emitting materials).

[0020] The electronic device 1 includes an electronic circuit 56. The electronic circuit 56 controls the operation (emission of light in the organic EL panel) of the operating elements 50. The electronic circuit 56 may supply signals to a driver circuit for driving the operating elements 50 (circuit including drive elements 120, for example). The electronic circuit 56 may include a scanning line driver for the display section. The electronic circuit 56 is electrically connected with the second electrodes 52. The electronic circuit 56 is provided between the second wiring pattern 20 and the operating region 54. In more detail, the electronic circuit 56 is provided between the first section 30 of the first split wiring pattern 11 (or the first sections 36 and 42 of the second and third split wiring patterns 12 and 13) and the operating region 54. TFTs (thin film transistors) may be part of the electronic circuit 56. The electronic circuit 56 is formed between the operating region 54 and the first wiring pattern 10.

[0021] At least one (two or more in many cases) third wiring pattern 60 is pulled out in a direction in which the first wiring pattern 10 or the second wiring pattern 20 opens (left direction in FIG. 2). The third wiring pattern 60 is electrically connected with the operating elements 50. The third wiring pattern 60 is pulled out from at least

one of the second electrodes 52 and the electronic circuit 56 (both in the example shown in FIG. 2). A plurality of the third wiring patterns 60 include wiring patterns for supplying data signals to the driver circuit for driving the operating elements 50 (circuit including the drive elements 120, for example). The wiring patterns pulled out from the operating region 54 (second electrodes 52) among the third wiring patterns 60 may supply the data signals to the display section. The third wiring patterns 60 have terminals 62. A plurality of the terminals 62 of a plurality of the third wiring patterns 60 are arranged in the widthwise direction. A plurality of the terminals 62 are arranged so that the tips are uniformly positioned. The third wiring patterns 60 are pulled out toward one side of the substrate 64. Pitches P_1 and P_2 of a plurality of the terminals 14 of the first and second wiring patterns 10 and 20 are greater than a pitch P_3 of a plurality of the terminals 62 of the third wiring patterns 60. The width of a plurality of the terminals 14 of the first and second wiring patterns 10 and 20 is greater than the width of a plurality of the terminals 62 of the third wiring patterns 60. The terminals 14 and 62 are formed at the edge of the substrate 64. The substrate 64 has a plurality of sides. The terminals 14 and 62 are formed in the area located on one side (edge which forms one side).

[0022] The first and second wiring patterns 10 and 20 are formed on the substrate 64 as a support member. The substrate 64 has light transmissibility. The substrate 64 is a glass substrate, for example. The electronic circuit 56 may be formed on the substrate 64. The second electrodes 52 may be formed on the substrate 64. All the wiring patterns (first to third wiring patterns 10, 20, and 60, for example) may be pulled out toward one side of the substrate 64. In this case, an area of the electronic device 1 for mounting another electronic component (circuit board 100) is located on one side of the electronic device 1.

[0023] The conductive section 70 is electrically connected with the first wiring pattern 10. For example, the conductive section 70 may be formed on the first wiring pattern 10. Connection resistance between the conductive section 70 and the first wiring pattern 10 can be adjusted by a material for the first wiring pattern 10 in the area in contact with the conductive section 70. For example, a surface layer for a plurality of layers which make up the first wiring pattern 10 may be formed of the same material as the second electrodes 52 (ITO, for example), as shown in FIG. 3.

[0024] The conductive section 70 is formed at a position higher than the substrate. The conductive section 70 is formed to surround the operating region 54 from three directions. The conductive section 70 is disposed on the side opposite to the operating region 54 with the second wiring pattern 20 interposed therebetween. The conductive section 70 is formed longer than one side of the operating region 54. The details described for the first wiring pattern 10 are applied to the conductive section 70. The conductive section 70 is provided in a region in which the

first wiring pattern 10 overlaps a first electrode 72. The conductive section 70 electrically connects the first wiring pattern 10 with the first electrode 72.

[0025] The first electrode 72 is electrically connected with the conductive section 70. The first electrode 72 is formed in a layer differing from the first wiring pattern 10. The first electrode 72 has an area which overlaps the first wiring pattern 10. The first electrode 72 supplies electrical energy to a plurality of the operating elements 50 in common. Since the conductive section 70 is formed with a large length (large size), the first wiring pattern 10 can be electrically connected with first electrode 72 while decreasing the resistance. The conductive section 70 and the first electrode 72 may be integrally formed of a single material. Part of the first electrode 72 overlaps the operating elements 50. Energy (current or voltage, for example) can be supplied to the operating elements 50 from the first and second electrodes 72 and 52. The first electrode 72 is located at a position higher than the second electrodes 52. The first and second electrodes 72 and 52 may face each other at least in part. The first and second electrodes 72 and 52 sandwich the operating elements 50 at least in part. The first electrode 72 may cover the first and second wiring patterns 10 and 20.

[0026] The first electrode 72 is supported by an insulating layer 74. The insulating layer 74 may seal the operating elements 50. The insulating layer 74 is provided between the first wiring pattern 10 and the first electrode 72 in the area excluding the conductive section 70. The insulating layer 74 is formed on the first and second wiring patterns 10 and 20, the electronic circuit 56, and the like. Openings are formed in the insulating layer 74 in the area necessary for electrical connection. For example, a groove which passes through the insulating layer 74 is formed on the first wiring pattern 10 along the direction in which the first wiring pattern 10 extends. The conductive section 70 is formed in the groove. Through holes are formed on the operating elements 50, and the first electrode 72 and each of the operating elements 50 are electrically connected through the through holes. As a modification example, the first electrode 72 may be supported by the substrate.

[0027] At least one or a plurality of electronic components 101 to 105 are mounted on the circuit board 100. A circuit for driving an organic EL panel is formed by the electronic components 101 to 105, for example. The circuit board 100 is installed in the electronic device 1. An interconnection pattern (a plurality of wiring patterns) 106 is formed on the circuit board 100 (on the back face in FIG. 1). The ends of the interconnection pattern (a plurality of wiring patterns) 106 are electrically connected with the terminals 14 and 62 and the like of the electronic device 1. An anisotropic conductive film (ACF), an anisotropic conductive paste (ACP), or the like may be used to electrically connect the interconnection pattern 106 with the terminals.

[0028] The first and second wiring patterns 10 and 20 of the electronic device 1 are electrically connected with

power supply circuits included in the electronic components 101 and 105, for example. Current is supplied to the operating elements 50 from the first and second electrodes 72 and 52 through the first and second wiring patterns 10 and 20. In this embodiment, the first electrode 72 is a cathode. However, the second electrode 52 may be a cathode. One group of the third wiring patterns 60 electrically connected with the electronic circuit 56 of the electronic device 1 is electrically connected with timing signal generating circuits included in the electronic components 102 and 104, for example. Another group of the third wiring patterns 60 electrically connected with the electronic circuit 56 of the electronic device 1 is electrically connected with power supply circuits included in the electronic components 101 and 105, for example. Another group of the third wiring patterns 60 electrically connected with the second electrodes 52 is electrically connected with an image signal output circuit included in the electronic component 103, for example.

[0029] The electronic device according to this embodiment has the above-described configuration. The operation of the electronic device is described below. As described above, light-emitting materials are provided to the operating elements 50, and current is supplied to the operating elements 50. Current is supplied from the first and second wiring patterns 10 and 20. For example, the first split wiring pattern 11 of the second wiring pattern 20 which is wider than the second and third split wiring patterns 12 and 13 supplies heavy current (or stable current) to a material exhibiting poor light-emitting efficiency (polymer material (blue light-emitting material, for example)). The second and third split wiring patterns 12 and 13 supply current to low-molecular-weight materials (red and green light-emitting materials, for example). Light produced in the operating elements 50 is transmitted through the substrate 64, as shown in FIG. 3. This enables an image or the like to be displayed from the side of the substrate 64. In this embodiment, the first wiring pattern 10 is a cathode. Control of current and selection of pixels from which light is emitted are performed by the image signal output circuit, the timing signal generating circuit, the electronic circuit 56 (scanning driver), and the like.

[0030] FIG. 4 is a view illustrating a circuitry of an electronic device according to one embodiment of the present invention. This circuit is a circuit of an active matrix type display device utilizing organic EL elements. A plurality of scanning lines 110, a plurality of signal lines 112 extending in a direction which intersects the scanning lines 110, and a plurality of common power supply lines 114 extending along the signal lines 112 are formed in the operating region 54 (display section). The scanning lines 110 are electrically connected with a scanning line driver (which includes shift registers and level shifters, for example) of the electronic circuit 56. The signal lines 112 are electrically connected with a signal line driver (which includes shift registers, level shifters, video lines, and analog switches, for example) of the electronic compo-

nent 103. The common power supply line 114 is electrically connected with the second wiring pattern 20 (one of first to third split wiring patterns 11 to 13). The operating elements 50 (pixels) are provided corresponding to each intersection point of the scanning lines 110 and the signal lines 112.

[0031] Switching elements 116 are electrically connected with the scanning lines 110 corresponding to each pixel. In the case where the switching element 116 is a thin film transistor (MOSFET), the scanning line 110 is electrically connected with a gate electrode of the switching element 116. Capacitors 118 are electrically connected with the signal lines 112 corresponding to each pixel. In more detail, the capacitor 118 is electrically connected between the signal line 112 and the common power supply line 114, and is capable of retaining charges corresponding to the image signal from the signal line 112. The switching element 116 is electrically connected between the capacitor 118 and the signal line 112. The switching element 116 is controlled by a scanning signal from the scanning line 110. The switching element 116 controls charge storage in the capacitor 118.

[0032] The drive element 120 is controlled by the amount of charge or the presence or absence of charge retained in the capacitor 118. In the case where the drive element 120 is a thin film transistor (MOSFET), a gate electrode of the drive element 120 and an electrode of the capacitor 118 on the side of the signal line 112 are electrically connected. The drive element 120 is electrically connected between the common power supply line 114 and the operating element 50. Specifically, the drive element 120 controls supply of current from the common power supply line 114 to the operating element 50.

[0033] When the switching element 116 is turned ON by the scanning signal of the scanning line 110, charges are retained in the capacitor 118 by the potential difference between the signal line 112 and the common power supply line 114. The control state of the drive element 120 is determined depending on the charge retained in the capacitor 118. Current flows into the second electrode 52 from the common power supply line 114 through a channel of the drive element 120, and current flows into the first electrode 72 through the operating element 50. The operating element 50 emits light corresponding to the amount of current flowing through the operating element 50. Specifically, the operating element 50 is driven by a driver circuit (circuit including the drive elements 120). The driver circuit is electrically connected with the second electrodes 52. The driver circuit is electrically connected with the second wiring pattern 20.

[0034] A method of manufacturing an electronic device according to this embodiment is described below. The method of manufacturing the electronic device comprises forming the first and second wiring patterns 10 and 20, the first and second electrodes 72 and 52, the conductive section 70, and the operating element 50. These members may be stacked on the substrate 64. The conductive section 70 is disposed on the side opposite to

the operating region 54 with the second wiring pattern 20 interposed therebetween. The conductive section 70 is formed with a length at least equal to one side of a region in which the operating element 50 is formed. According to the present embodiment, a large conductive section 70 disposed outside the second wiring pattern 20 can be formed. The conductive section 70 can be electrically connected with the first electrode 72 while decreasing the resistance by forming the conductive section 70 with a length at least equal to one side of the operating region 54.

[0035] Figs 5 and 6 respectively show a notebook personal computer 1000 and a portable telephone 2000 as examples of the electronic instruments including the electronic device according to one embodiment of the present invention.

Claims

1. An organic electroluminescent device comprising:

a substrate (64);
 a plurality of organic electroluminescent elements (50) provided over the substrate (64) and defining an operating region (54);
 a first wiring pattern (10) provided over the substrate (64) at a position closer to an edge portion of the substrate (64) than the operating region (54);
 a first electrode (72) provided in a layer different from the first wiring pattern (10), at least partially overlapping the first wiring pattern (10) in a region, and arranged for supply of electrical energy to the plurality of organic electroluminescent elements (50) in common;
 a conductive section (70) provided in the region in which the first wiring pattern (10) overlaps the first electrode (72), and arranged to electrically connect the first wiring pattern (10) to the first electrode (72),
 a second electrode (52) disposed opposite from the first electrode (72) with a first element (50) that is one of the plurality of organic electroluminescent elements (50) interposed between the first electrode (72) and the second electrode (52), the second electrode (52) being interposed between the first element (50) and the substrate (64), and arranged for the supply of the electrical energy to the first element (50);
 a driving element (120) electrically connected to the first element (50);
 a second wiring pattern (20) electrically connected to the second electrode (52) through the driving element (120);
 a third wiring pattern (60) supplying a data signal for driving the first element (50); and
 a terminal (62) provided between a first side of

the substrate (64) and the operating region (54) and coupled to the third wiring pattern (60),
characterised in that:

- 5 the first wiring pattern (10) and the conductive section (70) extend continuously around the operating region (54), while having an opening facing said first side of the substrate (64);
- 10 the first wiring pattern (10) has a plurality of layers including a first layer and second layer, the first layer being disposed between the substrate (64) and the second layer; and the third wiring pattern (60) extends from the terminal (62) through the opening toward the operating region (54).
2. The organic electroluminescent device as defined in claim 1,
- 20 wherein the second layer of the first wiring pattern (10) is a surface layer of the first wiring pattern (10); and wherein the second layer of the first wiring pattern (10) is formed of the same material as the second electrode (52).
- 25 3. The organic electroluminescent device as defined in claim 1 or 2,
- 30 wherein the conductive section (70) extends continuously around the operating region (54), while having an opening facing said first side of the substrate (64).
- 35 4. The organic electroluminescent device as defined in at least one of claims 1 to 3,
- 40 the first wiring pattern (10) and the conductive section (70) being continuously disposed along three sides of the substrate (64) that are other than the first side of the substrate (64), a shape of the operating region (54) being rectangular or square.

Patentansprüche

- 45 1. Organische elektrolumineszente Vorrichtung, die Folgendes aufweist:
 einen Träger (64);
 mehrere organische elektrolumineszente Elemente (50), die auf dem Träger (64) bereitgestellt sind und eine Betriebsregion (54) definieren;
 eine erste Leiterbahnstruktur (10), die auf dem Träger (64) an einer Position bereitgestellt ist, die näher an einem Randteil des Trägers (64) als an der Betriebsregion (54) ist;
 eine erste Elektrode (72), die in einer Schicht bereitgestellt ist, die von der ersten Leiter-

bahnstruktur (10) verschieden ist, die die erste Leiterbahnstruktur (10) in einer Region wenigstens teilweise überlappt und zur Versorgung der mehreren organischen elektrolumineszenten Elementen (50) gemeinsam mit elektrischer Energie angeordnet ist;

einen leitenden Abschnitt (70), der in der Region bereitgestellt ist, in der die erste Leiterbahnstruktur (10) die erste Elektrode (72) überlappt, und zum elektrischen Verbinden der ersten Leiterbahnstruktur (10) mit der ersten Elektrode (72) angeordnet ist, eine zweite Elektrode (52), die gegenüber der ersten Elektrode (72) angeordnet ist, wobei ein erstes Element (50), das eines der mehreren organischen elektrolumineszenten Elemente (50) ist, zwischen der ersten Elektrode (72) und der zweiten Elektrode (52) eingefügt ist, wobei die zweite Elektrode (52) zwischen das erste Element (50) und den Träger (64) eingefügt ist und zur Versorgung des ersten Elements (50) mit der elektrischen Energie angeordnet ist; ein Ansteuerelement (120), das elektrisch mit dem ersten Element (50) verbunden ist; eine zweite Leiterbahnstruktur (20), die durch das Ansteuerelement (120) elektrisch mit der zweiten Elektrode (52) verbunden ist; eine dritte Leiterbahnstruktur (60), die ein Datensignal zum Ansteuern des ersten Elements (50) anlegt; und einen Anschluss (62), der zwischen einer ersten Seite des Trägers (64) und der Betriebsregion (54) bereitgestellt ist und mit der dritten Leiterbahnstruktur (60) gekoppelt ist,

dadurch gekennzeichnet, dass:

die erste Leiterbahnstruktur (10) und der leitende Abschnitt (70) ununterbrochen um die Betriebsregion (54) verlaufen, während sie eine Öffnung haben, die der genannten ersten Seite des Trägers (64) zugekehrt ist; die erste Leiterbahnstruktur (10) mehrere Schichten hat, einschließlich einer ersten Schicht und einer zweiten Schicht, wobei die erste Schicht zwischen dem Träger (64) und der zweiten Schicht angeordnet ist; und die dritte Leiterbahnstruktur (60) von dem Anschluss (62) durch die Öffnung zur Betriebsregion (54) hin verläuft.

2. Organische elektrolumineszente Vorrichtung nach Anspruch 1, wobei die zweite Schicht der ersten Leiterbahnstruktur (10) eine Oberflächenschicht der ersten Leiterbahnstruktur (10) ist; und wobei die zweite Schicht der ersten Leiterbahnstruktur (10) aus dem gleichen Material wie die zweite Elektrode (52) gebildet ist.

3. Organische elektrolumineszente Vorrichtung nach Anspruch 1 oder 2, wobei der leitende Abschnitt (70) ununterbrochen um die Betriebsregion (54) verläuft, während er eine Öffnung hat, die der genannten ersten Seite des Trägers (64) zugekehrt ist.

4. Organische elektrolumineszente Vorrichtung nach wenigstens einem der Ansprüche 1 bis 3, wobei die erste Leiterbahnstruktur (10) und der leitende Abschnitt (70) ununterbrochen an drei Seiten des Trägers (64) entlang, die anders als die erste Seite des Trägers (64) sind, angeordnet sind, wobei eine Form der Betriebsregion (54) rechteckig oder quadratisch ist.

Revendications

1. Dispositif électroluminescent organique comprenant :

un substrat (64) ;

une pluralité d'éléments électroluminescents organiques (50) fournie sur le substrat (64) et définissant une région opérationnelle (54) ;

une première configuration de câblage (10) fournie sur le substrat (64) à une position plus rapprochée d'une partie de bord du substrat (64) que la région opérationnelle (54) ;

une première électrode (72) fournie dans une couche différente de la première configuration de câblage (10), recouvrant au moins partiellement la première configuration de câblage (10) dans une région, et agencée pour fournir une énergie électrique à la pluralité d'éléments électroluminescents organiques (50) en commun ; une section conductrice (70) fournie dans la région dans laquelle la première configuration de câblage (10) recouvre la première électrode (72), et agencée pour connecter électriquement la première configuration de câblage (10) à la première électrode (72),

une seconde électrode (52) disposée opposée à la première électrode (72) avec un premier élément (50) qui est l'un de la pluralité d'éléments électroluminescents organiques (50) interposés entre la première électrode (72) et la seconde électrode (52), la seconde électrode (52) étant interposée entre le premier élément (50) et le substrat (64), et agencée pour fournir une énergie électrique au premier élément (50) ; un élément de commande (120) connecté électriquement au premier élément (50) ; une deuxième configuration de câblage (20) connectée électriquement à la seconde électrode (52) par le biais de l'élément de commande (120) ;

une troisième configuration de câblage (60) fournissant un signal de données pour commander le premier élément (50) ; et une borne (62) fournie entre un premier côté du substrat (64) et la région opérationnelle (54) et couplée à la troisième configuration de câblage (60),

caractérisé en ce que :

la première configuration de câblage (10) et la section conductrice (70) s'étendent continûment autour de la région opérationnelle (54), tout en ayant une ouverture faisant face audit premier côté du substrat (64) ;
la première configuration de câblage (10) comporte une pluralité de couches comportant une première couche et une seconde couche, la première couche étant disposée entre le substrat (64) et la seconde couche ;
et
la troisième configuration de câblage (60) s'étend depuis la borne (62) à travers l'ouverture vers la région opérationnelle (54).

2. Dispositif électroluminescent organique selon la revendication 1, dans lequel la seconde couche de la première configuration de câblage (10) est une couche de surface de la première configuration de câblage (10) ; et dans lequel la seconde couche de la première configuration de câblage (10) est formée du même matériau que la seconde électrode (52).
3. Dispositif électroluminescent organique selon la revendication 1 ou 2, dans lequel la section conductrice (70) s'étend continûment autour de la région opérationnelle (54), tout en ayant une ouverture faisant face audit premier côté du substrat (64).
4. Dispositif électroluminescent organique selon au moins l'une des revendications 1 à 3, la première configuration de câblage (10) et la section conductrice (70) étant disposées continûment le long de trois côtés du substrat (64) qui sont autres que le premier côté du substrat (64), une forme de la région opérationnelle (54) étant rectangulaire ou carrée.

FIG. 1

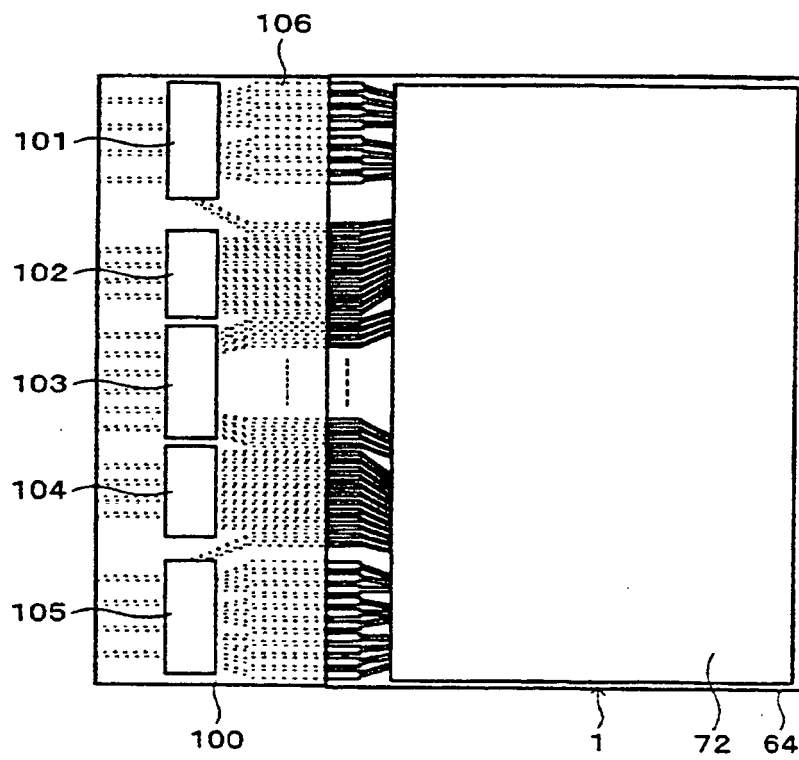


FIG. 2

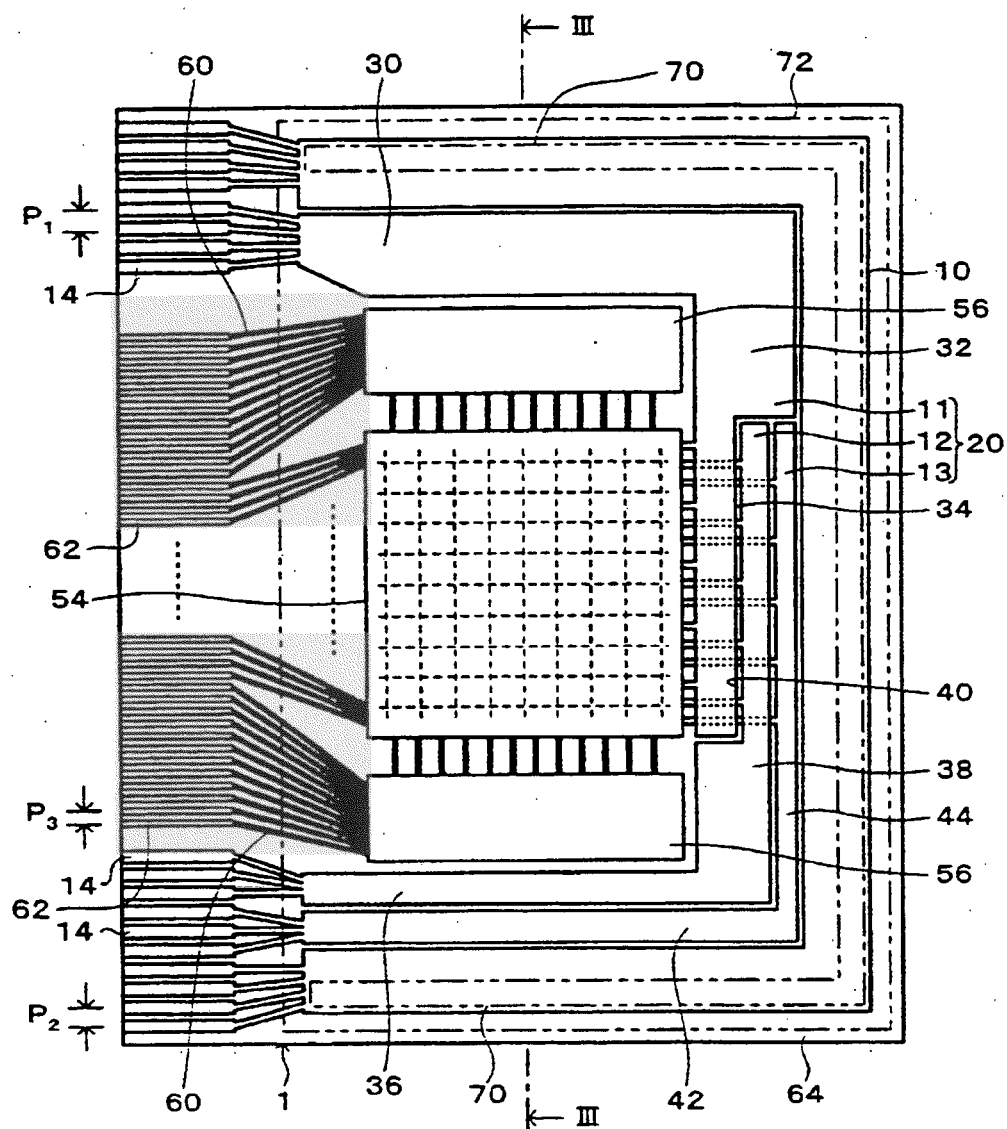


FIG. 3

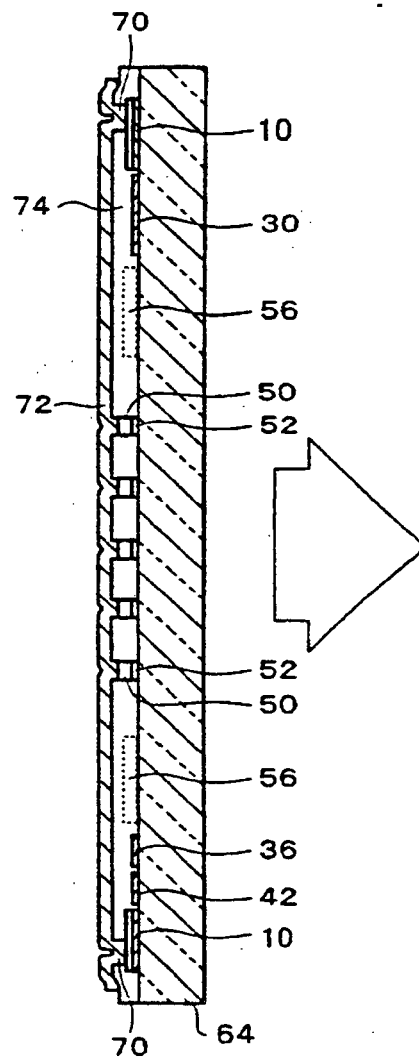


FIG. 4

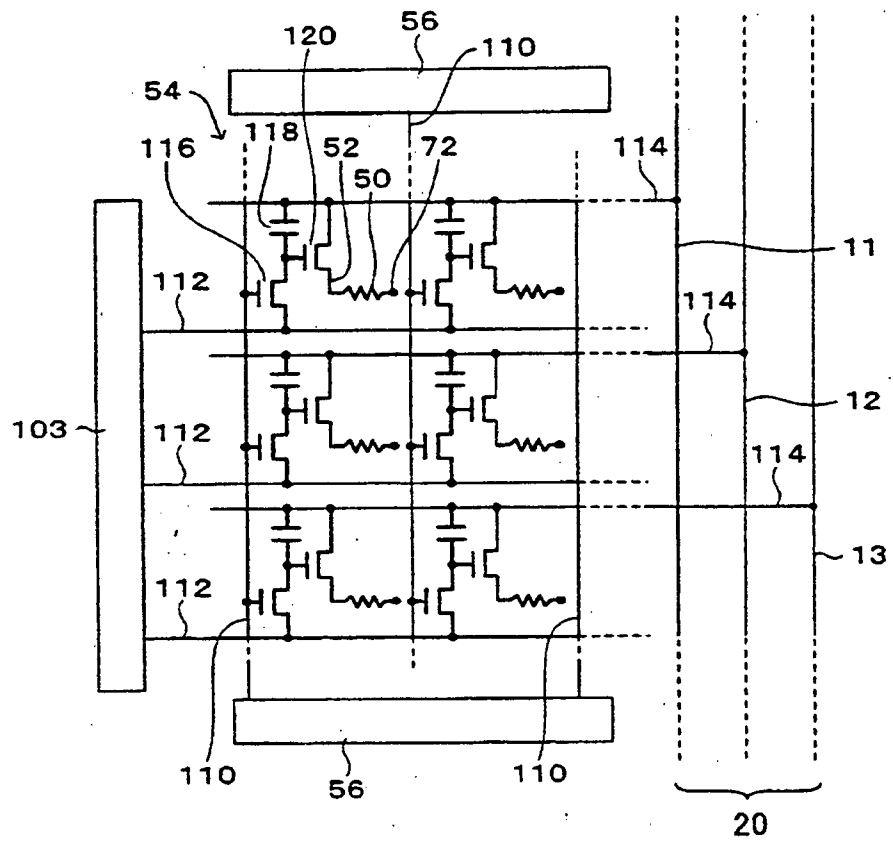


FIG. 5

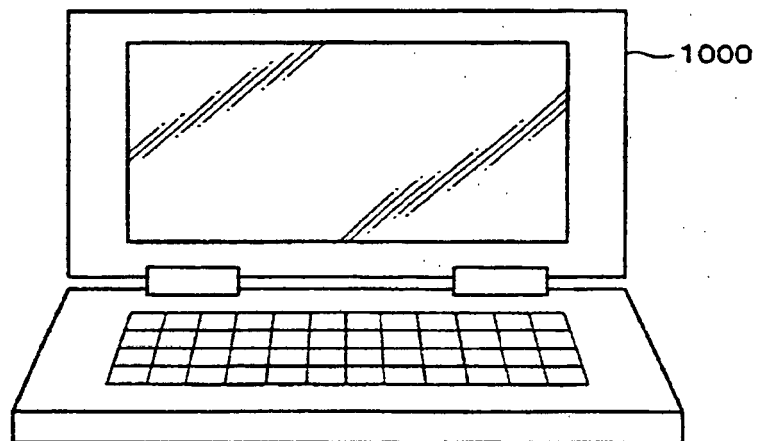
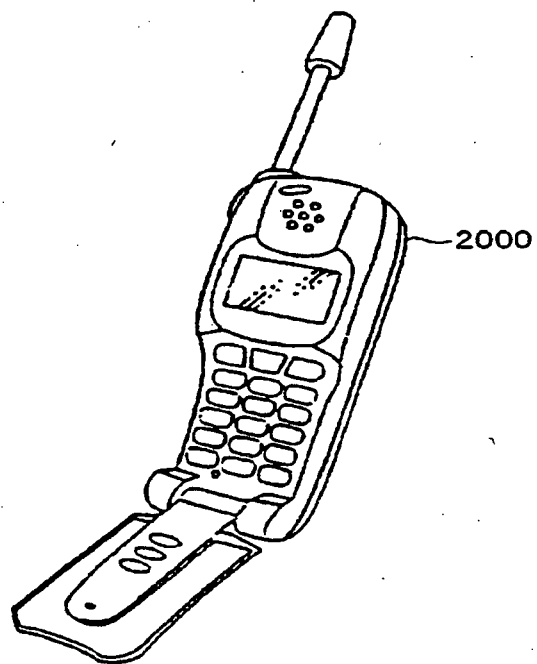


FIG. 6



REFERENCES CITED IN THE DESCRIPTION

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专利名称(译)	有机电致发光显示装置		
公开(公告)号	EP2034469B1	公开(公告)日	2018-01-17
申请号	EP2008170139	申请日	2002-09-13
[标]申请(专利权)人(译)	精工爱普生株式会社		
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IPC分类号	H01L27/32 G02F1/1345		
CPC分类号	G02F1/1345 G02F2001/13456 H01L27/3211 H01L27/3279 H01L27/329		
优先权	2001278628 2001-09-13 JP		
其他公开文献	EP2034469A1		
外部链接	Espacenet		

摘要(译)

一种电子设备，包括：基板；多个操作元件设置在基板的操作区域中；第一布线图案设置在基板中的操作区域外部，使得第一布线图案的宽度大于操作区域的宽度；第一电极形成在与第一布线图案不同的层中，与第一布线图案部分重叠，并向操作元件提供公共电能；导电部分设置在第一布线图案与第一电极部分重叠的区域中，将第一布线图案电连接到第一电极。

FIG. 1

